

Automotive-grade N-channel 100 V, 25 mΩ typ., 7.8 A STripFET™ F3 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

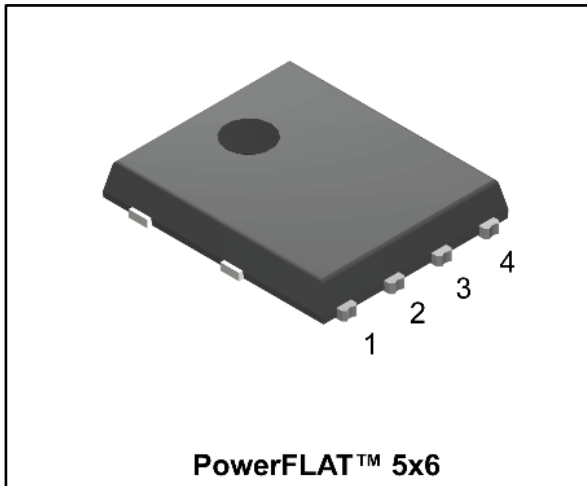
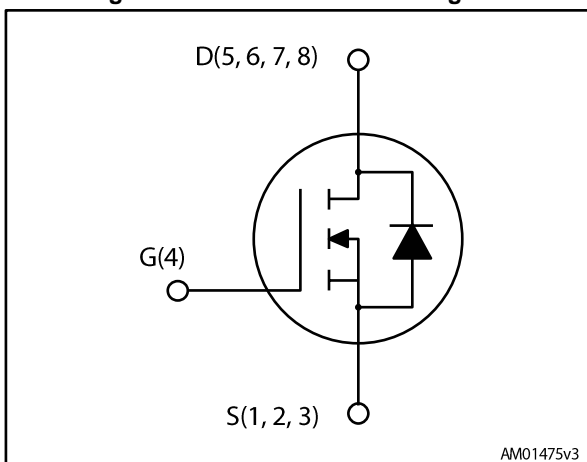


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STL8N10LF3	100 V	35 mΩ	7.8 A



- AEC-Q101 qualified
- Logic level V_{GS(th)}
- 175 °C maximum junction temperature
- 100% avalanche rated
- Wettable flank package

Applications

- Switching applications

Description

This device is an N-channel Power MOSFET developed using STripFET™ F3 technology. It is designed to minimize on-resistance and gate charge to provide superior switching performance.

Table 1: Device summary

Order code	Marking	Package	Packing
STL8N10LF3	8N10LF3	PowerFLAT™ 5x6	Tape and reel

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves).....	6
3	Test circuits	8
4	Package information	9
	4.1 PowerFLAT 5x6 type R package information	9
	4.2 Packing information.....	12
5	Revision history	14

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	100	V
V_{GS}	Gate-source voltage	± 20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$	20	A
$I_D^{(1)}$	Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$	20	A
$I_D^{(2)}$	Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$	7.8	A
$I_D^{(2)}$	Drain current (continuous) at $T_{pcb} = 100\text{ }^\circ\text{C}$	5.5	A
$I_{DM}^{(2)(3)}$	Drain current (pulsed)	31.2	A
$P_{TOT}^{(1)}$	Total dissipation at $T_C = 25\text{ }^\circ\text{C}$	70	W
$P_{TOT}^{(2)}$	Total dissipation at $T_{pcb} = 25\text{ }^\circ\text{C}$	4.3	W
I_{AV}	Not-repetitive avalanche current	7.8	A
$E_{AS}^{(4)}$	Single pulse avalanche energy	190	mJ
T_j	Operating junction temperature range	-55 to 175	$^\circ\text{C}$
T_{stg}	Storage temperature range		

Notes:

- (1) This value is rated according to $R_{thj-case}$ and limited by package
- (2) This value is rated according to $R_{thj-pcb}$
- (3) Pulse width limited by safe operating area.
- (4) Starting $T_J = 25\text{ }^\circ\text{C}$, $I_D = 7.8\text{ A}$, $V_{DD} = 25\text{ V}$.

Table 3: Thermal resistance

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	2.1	$^\circ\text{C/W}$
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	35	$^\circ\text{C/W}$

Notes:

- (1) When mounted on FR-4 board of 1 inch², 2oz Cu, $t < 10\text{ s}$

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On/Off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 250 μA	100			V
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 100 V			1	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 250 μA	1		3	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 4 A		25	35	mΩ
		V _{GS} = 5 V, I _D = 4 A		40	50	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C _{ISS}	Input capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V	-	970	-	pF
C _{OSS}	Output capacitance		-	115	-	
C _{RSS}	Reverse transfer capacitance		-	11.5	-	
Q _g	Total gate charge	V _{DD} = 50 V, I _D = 7.8 A, V _{GS} = 10 V (see Figure 13: "Test circuit for gate charge behavior")	-	20.5	-	nC
Q _{gs}	Gate-source charge		-	4	-	
Q _{gd}	Gate-drain charge		-	5	-	
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	3.65	-	Ω

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 50 V, I _D = 7.8 A, R _G = 4.7 Ω, V _{GS} = 10 V (see Figure 12: "Test circuit for resistive load switching times")	-	8.7	-	ns
t _r	Rise time		-	9.6	-	
t _{d(off)}	Turn-off delay time		-	50.6	-	
t _f	Fall time		-	5.2	-	

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		7.8	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		31.2	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{DS} = 7.8 \text{ A}$, $V_{GS} = 0$			1.3	V
t_{rr}	Reverse recovery time	$I_{SD} = 7.8 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$	-	42.5		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 48 \text{ V}$, $T_j = 150 \text{ }^\circ\text{C}$ (see Figure 14: "Test circuit for inductive load switching and diode recovery times")	-	87		nC
I_{RRM}	Reverse recovery current		-	4.08		A

Notes:

⁽¹⁾Pulse width limited by safe operating area

⁽²⁾Pulsed: pulse duration = 300 μs , duty cycle 1.5 %

2.1 Electrical characteristics (curves)

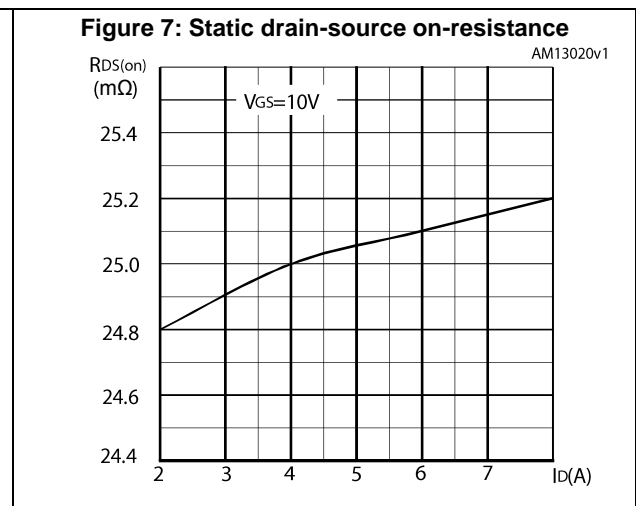
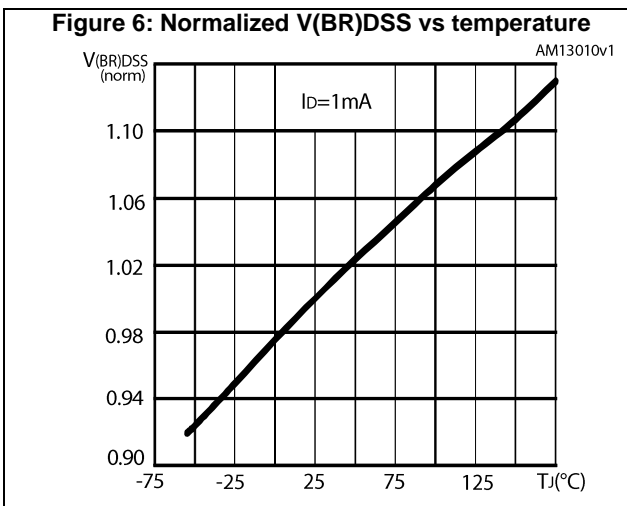
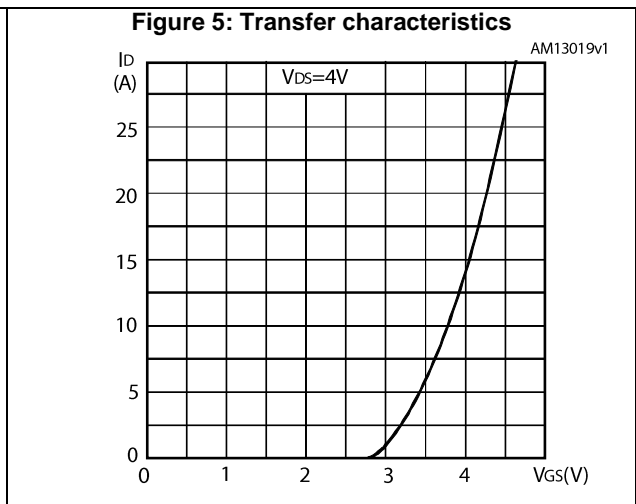
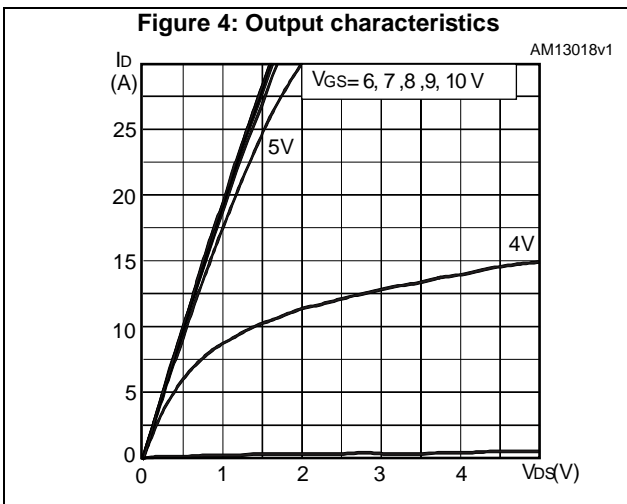
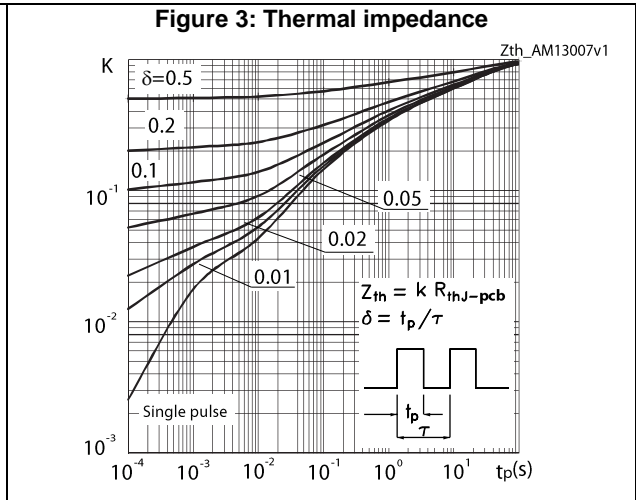
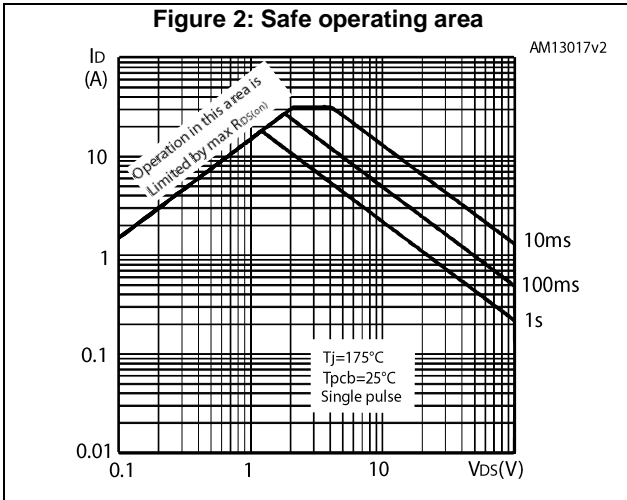


Figure 8: Gate charge vs gate-source voltage

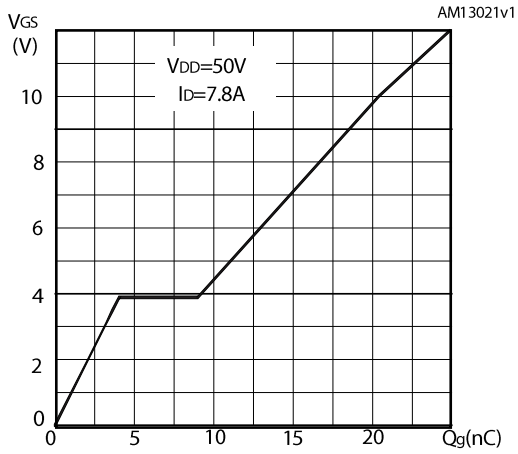


Figure 9: capacitance variation

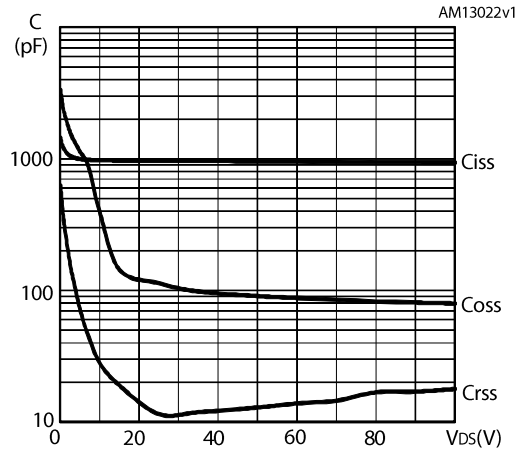


Figure 10: Normalized gate threshold voltage vs temperature

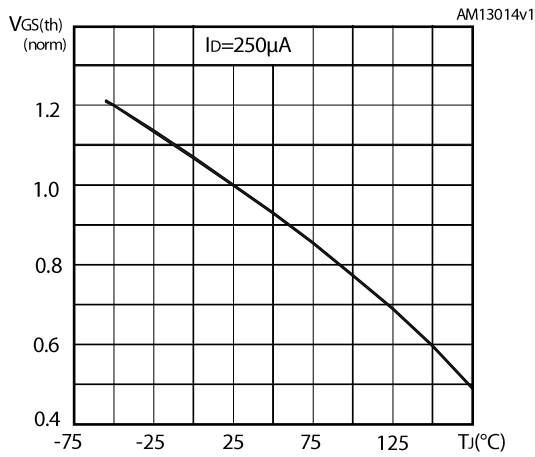
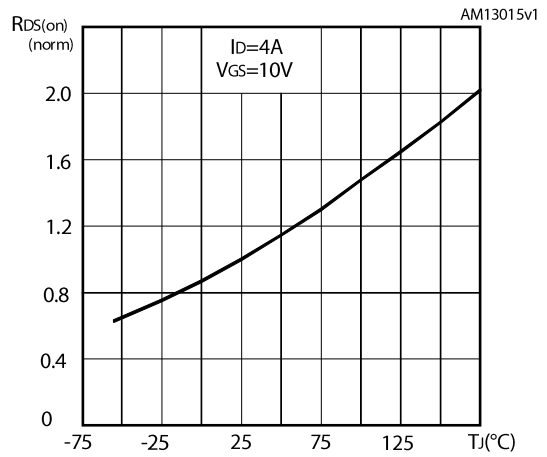


Figure 11: Normalized on resistance vs temperature



3 Test circuits

Figure 12: Test circuit for resistive load switching times



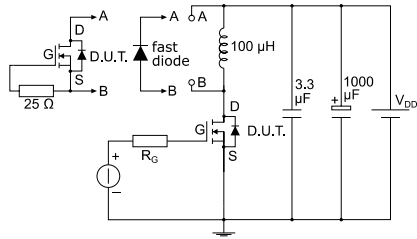
AM01468v1

Figure 13: Test circuit for gate charge behavior



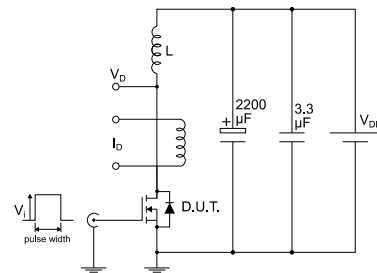
AM01469v1

Figure 14: Test circuit for inductive load switching and diode recovery times



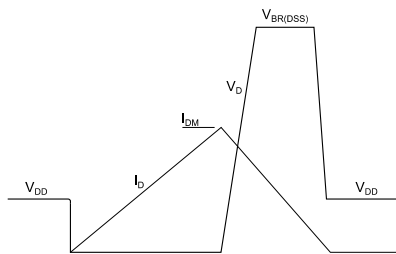
AM01470v1

Figure 15: Unclamped inductive load test circuit



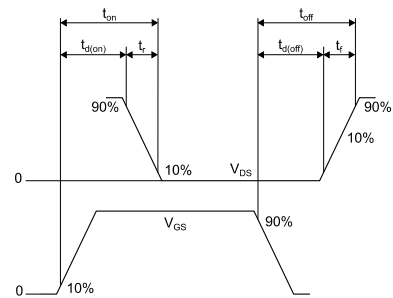
AM01471v1

Figure 16: Unclamped inductive waveform



AM01472v1

Figure 17: Switching time waveform



AM01473v1

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 PowerFLAT 5x6 type R package information

Figure 18: PowerFLAT™ 5x6 WF type R package outline

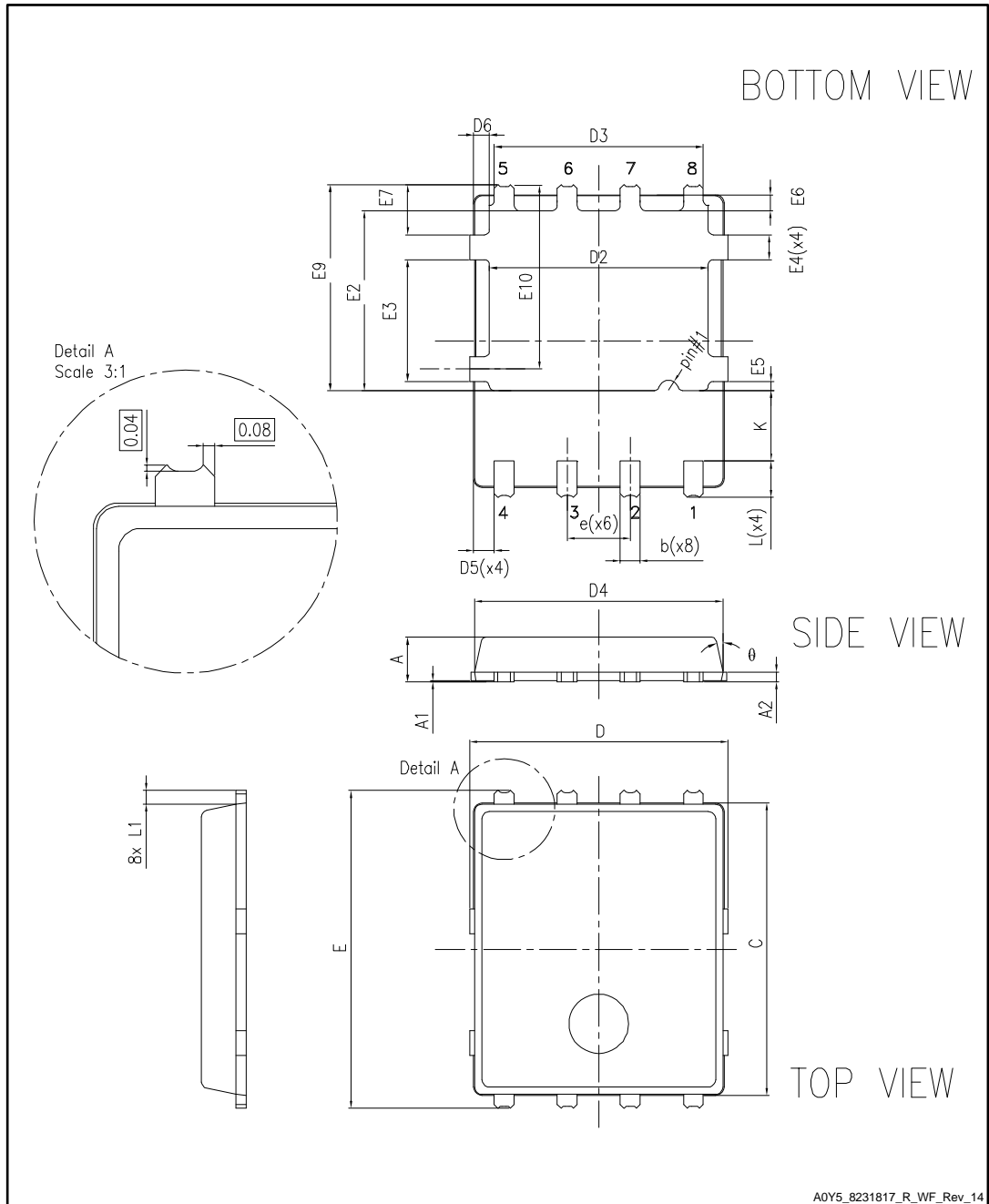


Table 8: PowerFLAT™ 5x6 WF type R mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.4	0.55
D6	0.15	0.3	0.45
e		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.275		1.575
L	0.725	0.825	0.925
L1	0.175	0.275	0.375
θ	0°		12°

Figure 19: PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)

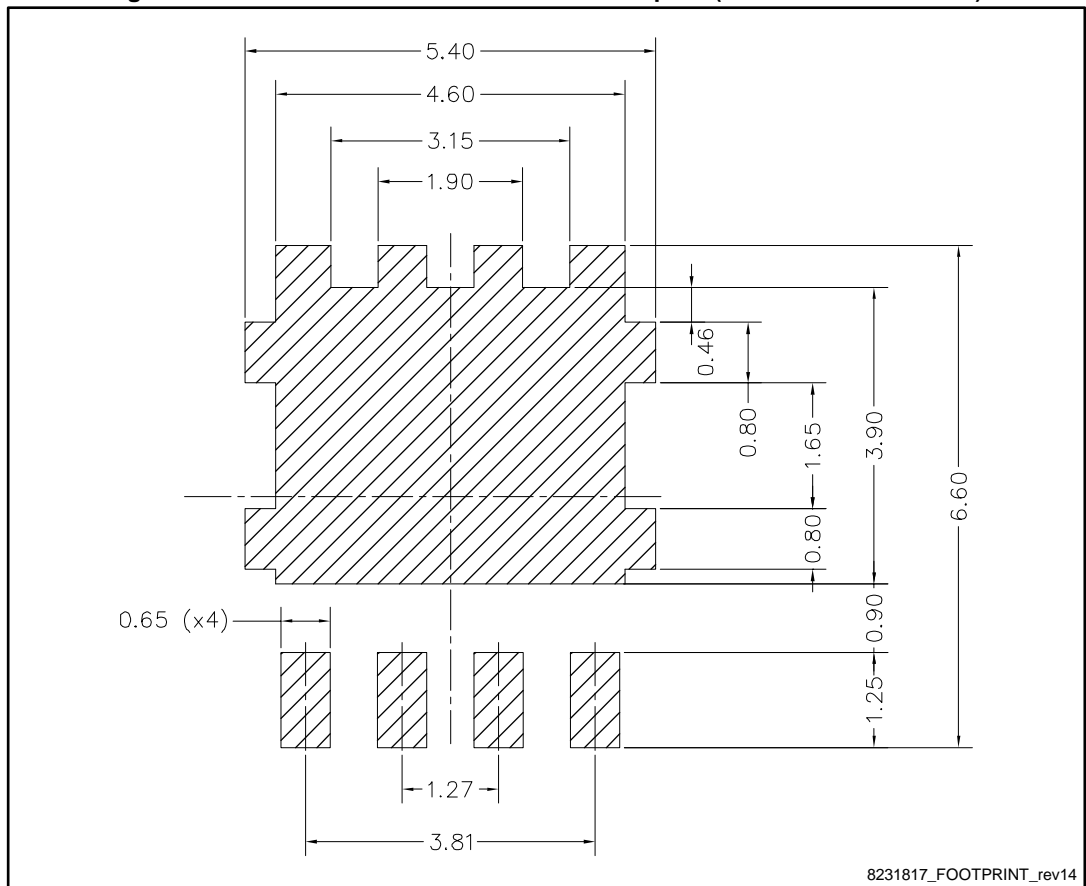
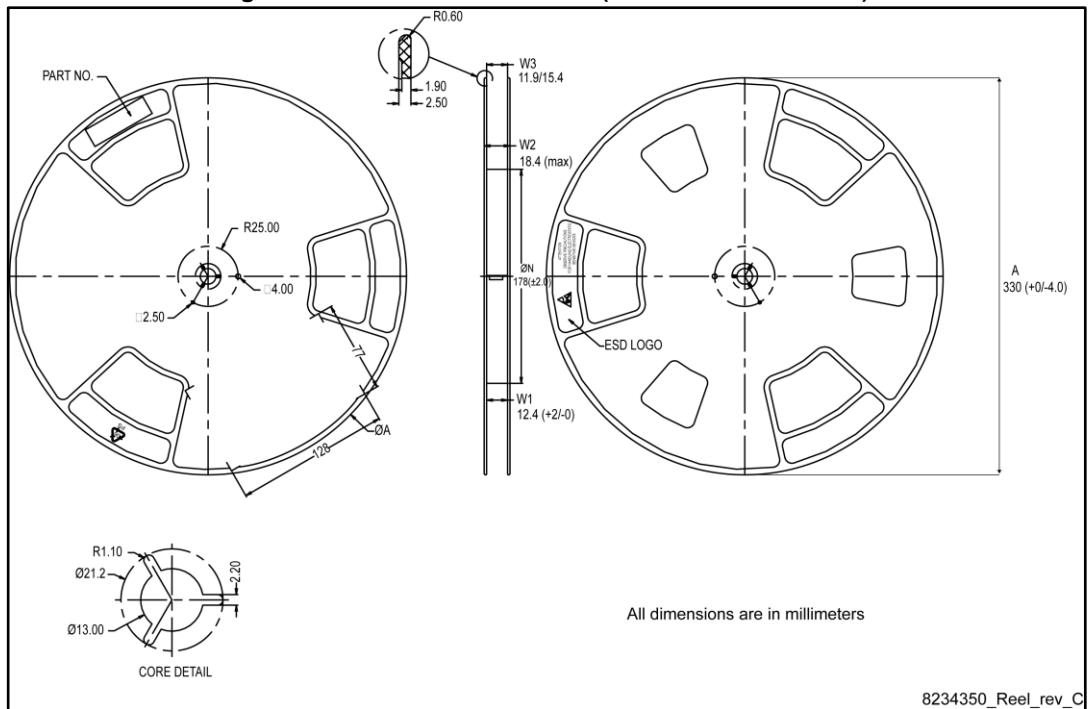


Figure 22: PowerFLAT™ 5x6 reel (dimensions are in mm)



5 Revision history

Table 9: Document revision history

Date	Revision	Changes
17-Jan-2013	1	First release.
18-May-2015	2	Updated Section 4: Package information. Added Section 5: Packing information. Minor text changes.
09-Nov-2016	3	Updated features in cover page and <i>Table 2: Absolute maximum ratings</i> . Updated <i>Section 4: Package information</i> . Minor text changes
28-Nov-2016	4	Updated test conditions in <i>Table 4: "On/Off states"</i> .

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics – All rights reserved



Стандарт Электрон Связь

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331